■ General Description

The SM8312 is a monolithic integrated circuit that provide all the active functions for a step-down switching regulator, capable of driving a 2A load without additional transistor component. Requiring a minimum number of external component, the board space can be saved easily. The external shutdown function can be controlled by TTL logic level and then come into standby mode. The internal compensation makes feedback control have good line and load regulation without external design. Regarding protected function, thermal shutdown is to prevent over temperature operating from damage, and current limit is against over current operating of the output switch. The SM8312 operates at a switching frequency of 150KHz thus allowing smaller sized filter components than what would be needed with lower frequency switching regulators. Other features include a guaranteed +4% tolerance on output voltage under specified input voltage and output load conditions, and +15% on the oscillator frequency. The output version included fixed 3.3V, 5V, 12V, and an adjustable type. The packages are available in a standard 8-lead SOP8 package and a 5-lead TO-263(U).

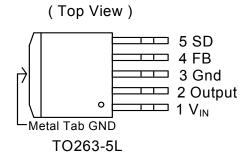
■ Features

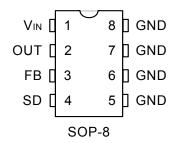
- 3.3V, 5V, 12V and adjustable output versions
- Adjustable version output voltage range, 1.23V to 37V ±4% max over line and load condition
- Available in TO220-5L and TO263-5L packages
- Voltage mode non-synchronous PWM control
- Thermal-shutdown and current-limit protection
- ON/OFF shutdown control input
- Input voltage range up to 40V
- Output load current: 2A
- 150KHz fixed frequency internal oscillator
- Low power standby mode
- Built-in switching transistor on chip

■ Applications

- Simple High-efficiency step-down(buck) regulator
- Efficient preregulator for linear regulators
- On-card switching regulators
- Positive to negative converter
- Battery Charger

■ Pin Assignments

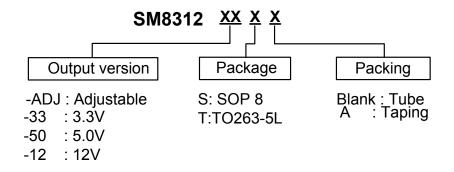




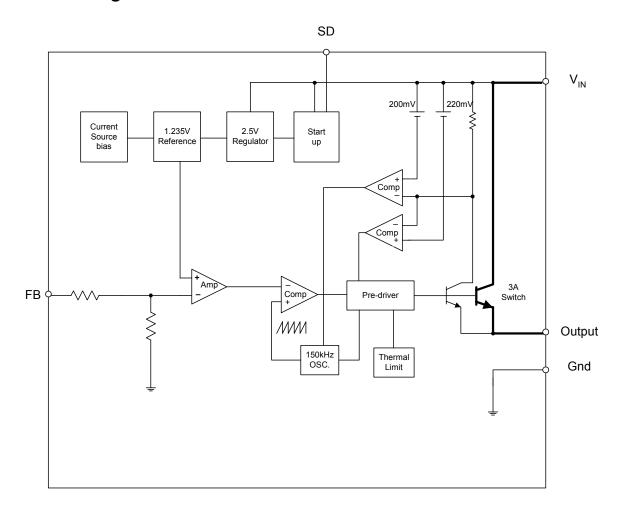
Pin Descriptions

Name	Description					
V_{IN}	Operating voltage input					
Output	Switching output					
Gnd	Ground					
FB	Output voltage feedback control					
SD	ON/OFF Shutdown					

■ Ordering Information



■ Block Diagram



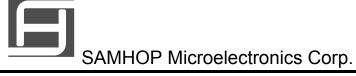


■ Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
V _{CC}	Supply Voltage	+45	V	
V _{SD}	ON/OFF Pin input voltage	-0.3 to +25	V	
V_{FB}	Feedback Pin voltage	-0.3 to +25	V	
V _{OUT}	Output voltage to Ground	-1	V	
P _D	Power dissipation	Internally limited	W	
T _{ST}	Storage temperature	-65 to +150	°C	
T _{OP}	Operating temperature	-40 to +125	°C	
V _{OP}	Operating voltage	+4.5 to +25	V	

■ Electrical Characteristics (All Output Voltage Versions) Unless otherwise specified, V_{IN}=12V for 3.3V, 5V, adjustable version and V_{IN}=24V for the 12V version. I_{LOAD} = 0.2A

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _B	Feedback bias current	V _{FB} =1.3V		-10	-50	nA
'B	T CCGBGGK BIGG GGITCH	(Adjustable version only)		10	-100	
Fosc	oscillator frequency		127	150	173	Khz
Fosc	Oscillator frequency		110		173	KIIZ
Fscp	Oscillator frequency of short circuit protect	When current limit occurred and VFB <0.55V		30	70	Khz
		I _{OUT} =2A			1.4	V
V_{SAT}	saturation voltage	no outside circuit V _{FB} =0V force driver on		1.25	1.5	
DC	Max. Duty Cycle(ON)	V _{FB} =0V force driver on		100		%
DC	Min. Duty cycle(OFF)	V _{FB} =12V force driver off	0			70
I _{CL}	current limit	peak current no outside circuit	2.4	2.8	3.3	Α
I ICL		V _{FB} =0 force driver on			3.6	, ,
IL	Output = 0V Output leakage	no outside circuit V _{FB} =12 force driver off			-200	uA
_	Output= -1V current	V _{IN} =24V		-5	-30	mA
ΙQ	Quiescent Current	V _{FB} =12 force driver off		5	10	mA
	Standby Quiescent	ON/OFF pin=5V	70	70	150	uA
I _{STBY}	Current	V _{IN} =24V		70	200	
V _{IL}	01//055	Low (regulator ON)	-		0.6	
V _{IH}	ON/OFF pin logic input threshold voltage	High (regulator OFF)	2.0	1.3	-	V
I _H	ON/OFF pin logic input current	V _{LOGIC} =2.5V (OFF)			-0.01	uA
Ι _L	ON/OFF pin input current	V _{LOGIC} =0.5V (ON)		-0.1	-1	
To	Over temperature	Tj increasing	175			°C
Ts	shutdown threshold	Tj decreasing		150		C



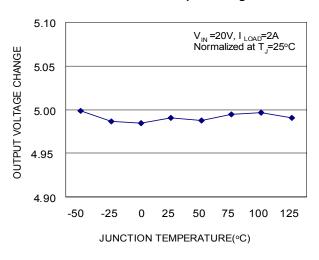
■ Electrical Characteristics (Continued)

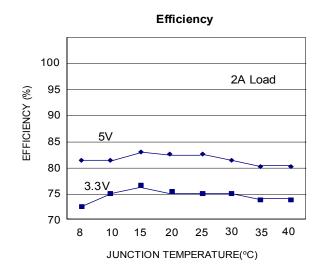
	Symbol	Parameter	Conditions	Тур.	Limit	Unit
SM8312-ADJ	V_{FB}	Output Feedback	$\begin{array}{c} 5V \leq V_{\text{IN}} \leq 40V \\ 0.2A \leq I_{\text{LOAD}} \leq 2A \\ V_{\text{OUT}} \text{ programmed for} \\ 3V \end{array}$	1.235	1.193/ 1.18 1.267/ 1.28	V V _{MIN} V _{MAX}
	η	Efficiency	V _{IN} = 12V, I _{LOAD} =2A	75		%
SM8312-3.3V	V _{out}	Output voltage	$5.5V \le V_{IN} \le 40V$ $0.2A \le I_{LOAD} \le 2A$	3.3	3.168/ 3.135 3.432/ 3.465	V V _{MIN} V _{MAX}
	η	Efficiency	V _{IN} = 12V, I _{LOAD} =2A	75		%
SM8312-5V	V _{OUT}	Output voltage	$8V \le V_{IN} \le 40V$ $0.2A \le I_{LOAD} \le 2A$	5	4.8/ 4.75 5.2/ 5.25	V V _{MIN} V _{MAX}
	η	Efficiency	V_{IN} = 12V, I_{LOAD} =2A	80		%
SM8312-12V	V _{OUT}	Output voltage	$15V \le V_{IN} \le 40V$ $0.2A \le I_{LOAD} \le 2A$	12	11.52/ 11.4 12.48/ 12.6	V V _{MIN} V _{MAX}
	η	Efficiency	V _{IN} = 15V, I _{LOAD} = 2A	90		%

Specifications with **boldface type** are for full operating temperature range, the other type are for T_J =25°C.

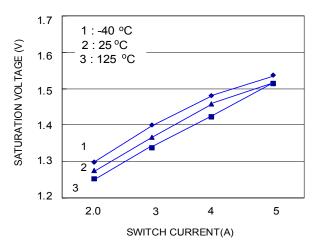
■ Typical Performance Characteristics

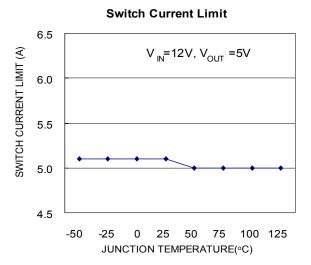
Typical Performance Characteristics Normalized Output Voltage



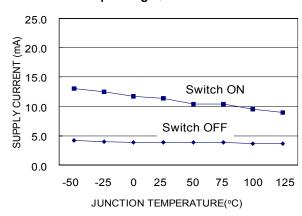


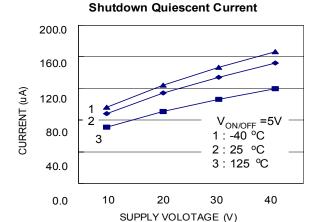
Switch Saturation Voltage





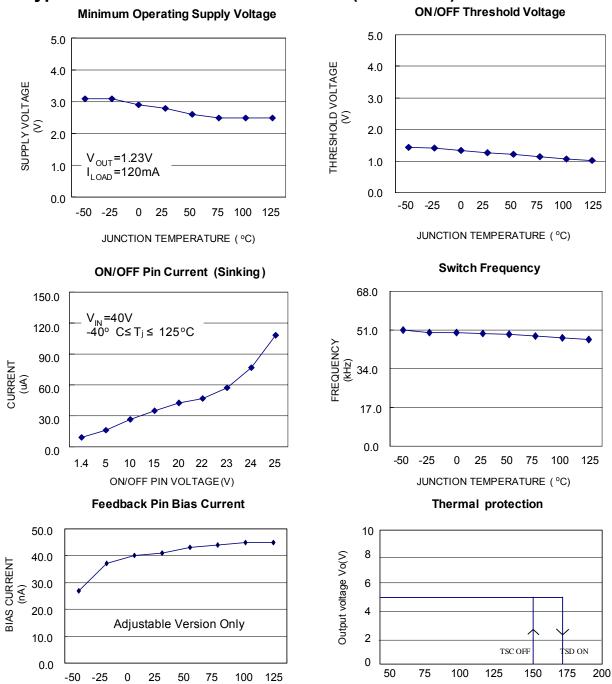
Operating Quiescent Current





JUNCTION TEMPERATURE (°C)

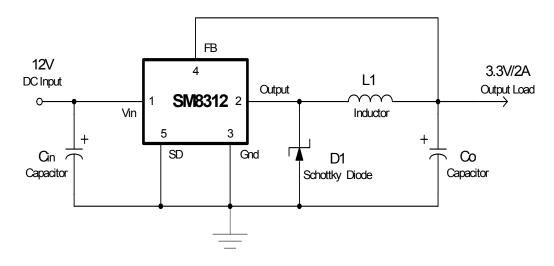
■ Typical Performance Characteristics (Continued)



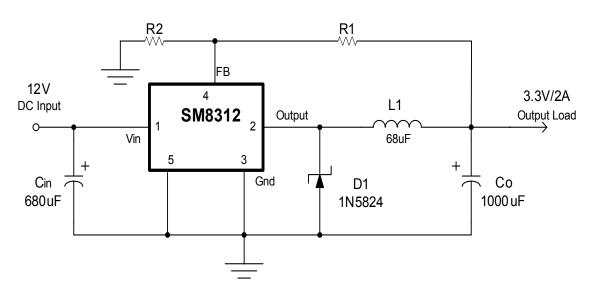
JUNCTION TEMPERATURE (°C)

■ Typical Application Circuit

(A) Fixed Type Circuit



(B) Adjustable Type Circuit



Vout = VFB x (1+R1/R2) VFB=1.23V

■ Function Description

Pin Functions

 $+V_{IN}$

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

Output

Internal switch and power output. The voltage at this pin switches between (+V $_{\rm IN}$ – V $_{\rm SAT}$) and approximately – 0.5V, with a duty cycle of approximately V $_{\rm OUT}$ / V $_{\rm IN}$. The PC board copper area connected to this pin should be kept a minimum in order to reduce the coupling sensitivity to the circuitry

Ground

Circuit ground.

Feedback

Complete the feedback loop by sensing the regulated output voltage

ON/OFF

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 100uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 25V) shuts the regulator down. If this shutdown feature is not needed, the $\overline{\text{ON}}/\text{OFF}$ pin can be wired to the ground pin or it can be left open, in either case the regulator will be in the ON condition.

Thermal Considerations

The SM8312 is available in two packages, a 8-pin SOP 8 and a 5-pin surface mount TO-263.

The SOP 8 package needs a heat sink under most conditions. The size of the heat sink depends on the input voltage, the output voltage, the load current and the ambient temperature. The SM8312 junction temperature rises above ambient temperature for a 2A load and different input and output voltages. The data for these curves was taken with the SM8312 operating as a buck switching regulator in an ambient temperature of 25°C (still air). These temperature rise numbers are

all approximate and there are many factors that can affect these temperatures. Higher ambient temperatures require more heat sinking.

The TO-263 surface mount package tab is designed to be soldered to the copper on a printed circuit board. The copper and the board are the heat sink for this package and the other heat producing components, such as the catch diode and inductor. The PC board copper area that the package is soldered to should be at least 0.8 in², and ideally should have 2 or more square inches of 2 oz. Additional copper area improves the thermal characteristics, but with copper areas greater than approximately 6 in², only small improvements in heat dissipation are realized. If further thermal improvements are needed, double sided, multilayer PC board with large copper areas and/or airflow are recommended.

■ Function Description (Continued)

SM8312 (TO-263 package) junction temperature rise above ambient temperature with a 2A load for various input and output voltages. This data was taken with the circuit operating as a buck switching regulator with all components mounted on a PC board to simulate the junction temperature under actual operating conditions. This curve can be used for a quick check for the approximate junction temperature for various conditions, but be aware that there are many factors that can affect the junction temperature. When load currents higher than 2A are used, double sided or multilayer PC boards with large copper areas and/or airflow might be needed, especially for high ambient temperatures and high output voltages.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper should be used in the board layout. (Once exception to this is the output (switch) pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

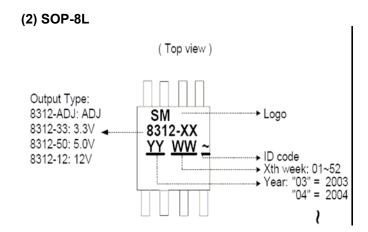
Package thermal resistance and junction temperature rise numbers are all approximate, and there are many factors that will affect these numbers. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness,

single or double-sided, multilayer board and the amount of solder on the board. The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat

to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.

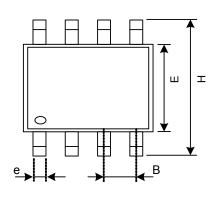
■ Marking Information

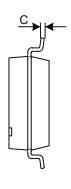
(1) TO263-5L (Top view) Output Type: 8313F-ADJ: ADJ SM Logo 8313F-33: 3.3V 8313FXX 8313F-50: 5.0V YY WW ~ ID code 8313F-12: 12V Xth week: 01~52 Year: "03" = 2003 "04" = 2004

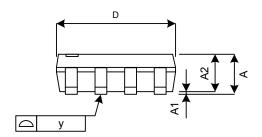


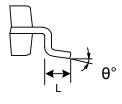
■ Package Information

(1) Package Type: SOP-8L





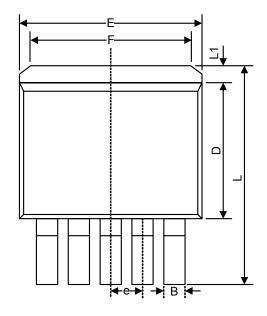


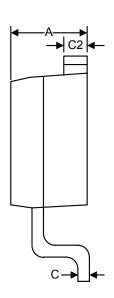


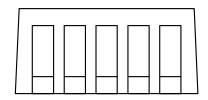
Symbol	Dimensions In Millimeters			Dimensions In Inches		
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.
Α	1.40	1.60	1.75	0.055	0.063	0.069
A1	0.10	-	0.25	0.040	-	0.100
A2	1.30	1.45	1.50	0.051	0.057	0.059
В	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.010
D	4.80	4.85	5.05	0.189	0.191	0.199
E	3.80	3.91	4.00	0.150	0.154	0.157
е	-	1.27	-	-	0.050	-
Н	5.79	5.99	6.20	0.228	0.236	0.244
L	0.38	0.71	1.27	0.015	0.028	0.050
у	-	-	0.10	-	-	0.004
θ	0°	-	8°	0°	-	8°

■ Package Information (Continued)

(2) Package Type: TO263-5L







Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.064	4.826	0.160	0.190	
В	0.508	0.991	0.020	0.039	
С	0.381	0.737	0.015	0.029	
C2	1.143	1.651	0.045	0.065	
D	8.382	9.652	0.330	0.380	
E	9.652	10.668	0.380	0.420	
е	1.702	BSC	0.067	BSC	
F	6.223	-	0.245	-	
L	14.605	15.875	0.575	0.625	
L1	-	1.676	-	0.066	